



## N-Channel Depletion-Mode Vertical DMOS FETs

### Ordering Information

BV <sub>DSX</sub> / BV <sub>DGX</sub>	R <sub>DS(ON)</sub> (max)	I <sub>DSS</sub> (min)	Order Number / Package		
			TO-92	TO-220	TO-243AA*
350V	25Ω	150mA	DN2535N3	DN2535N5	—
400V	25Ω	150mA	DN2540N3	DN2540N5	DN2540N8

\* Same as SOT-89. Product shipped on 2000 piece carrier tape reels.

### Features

- ☐ High input impedance
- ☐ Low input capacitance
- ☐ Fast switching speeds
- ☐ Low on resistance
- ☐ Free from secondary breakdown
- ☐ Low input and output leakage

### Applications

- ☐ Normally-on switches
- ☐ Solid state relays
- ☐ Converters
- ☐ Linear amplifiers
- ☐ Constant current sources
- ☐ Power supply circuits
- ☐ Telecom

### Absolute Maximum Ratings

Drain-to-Source Voltage	BV <sub>DSX</sub>
Drain-to-Gate Voltage	BV <sub>DGX</sub>
Gate-to-Source Voltage	± 20V
Operating and Storage Temperature	-55°C to +150°C
Soldering Temperature*	300°C

\* Distance of 1.6 mm from case for 10 seconds.

Product marking for TO-243AA:

**DN5D\***

Where \* = 2-week alpha date code

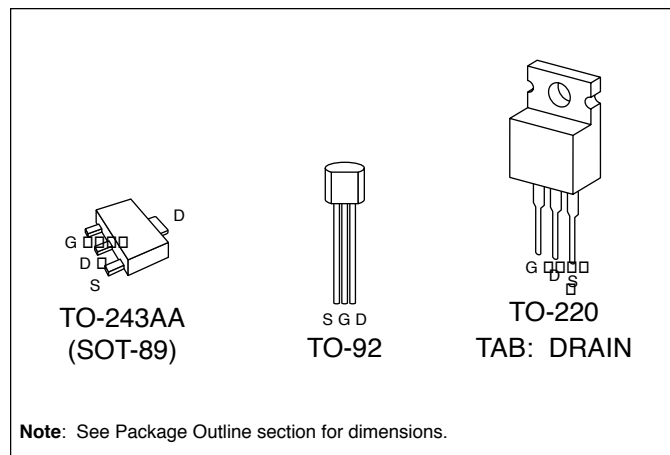
### Advanced DMOS Technology

**Not recommended for new designs. For products in TO-92 (N3) package and TO-243AA (N8) package, please use DN3535 or DN3545 instead.**

These low threshold depletion-mode (normally-on) transistors utilize an advanced vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces devices with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, these devices are free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

### Package Options



## Thermal Characteristics

Package	$I_D$ (continuous)*	$I_D$ (pulsed)	Power Dissipation @ $T_C = 25^\circ\text{C}$	$\theta_{JC}$ $^\circ\text{C/W}$	$\theta_{JA}$ $^\circ\text{C/W}$	$I_{DR}^*$	$I_{DRM}$
TO-92	120mA	500mA	1.0W	125	170	120mA	500mA
TO-220	500mA	500mA	15.0W	8.3	70	500mA	500mA
TO-243AA	170mA	500mA	1.6W ( $T_A = 25^\circ$ ) <sup>†</sup>	15	78 <sup>†</sup>	170mA	500mA

\*  $I_D$  (continuous) is limited by max rated  $T_J$ .

<sup>†</sup> Mounted on FR5 board, 25mm x 25mm x 1.57mm. Significant  $P_D$  increase possible on ceramic substrate.  $T_A = 25^\circ\text{C}$

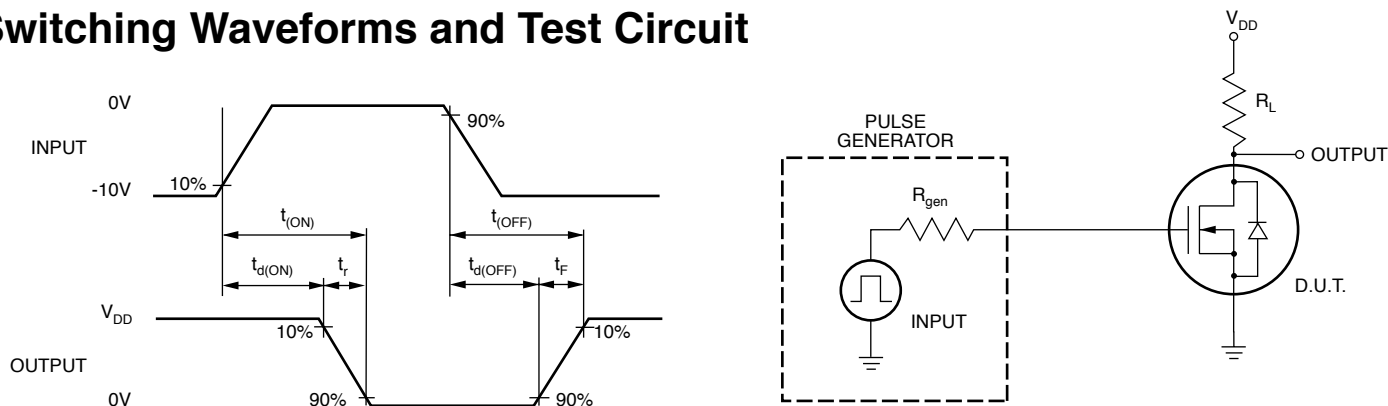
## Electrical Characteristics (@ $25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter		Min	Typ	Max	Unit	Conditions
$BV_{DSX}$	Drain-to-Source Breakdown Voltage	DN2540	400			V	$V_{GS} = -5V, I_D = 100\mu\text{A}$
		DN2535	350				
$V_{GS(OFF)}$	Gate-to-Source OFF Voltage		-1.5		-3.5	V	$V_{DS} = 25V, I_D = 10\mu\text{A}$
$\Delta V_{GS(OFF)}$	Change in $V_{GS(OFF)}$ with Temperature				4.5	mV/ $^\circ\text{C}$	$V_{DS} = 25V, I_D = 10\mu\text{A}$
$I_{GSS}$	Gate Body Leakage Current				100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
$I_{D(OFF)}$	Drain-to-Source Leakage Current				10	$\mu\text{A}$	$V_{GS} = -10V, V_{DS} = \text{Max Rating}$
					1	mA	$V_{GS} = -10V, V_{DS} = 0.8 \text{ Max Rating}$ $T_A = 125^\circ\text{C}$
$I_{DSS}$	Saturated Drain-to-Source Current		150			mA	$V_{GS} = 0V, V_{DS} = 25V$
$R_{DS(ON)}$	Static Drain-to-Source ON-State Resistance			17	25	$\Omega$	$V_{GS} = 0V, I_D = 120\text{mA}$
$\Delta R_{DS(ON)}$	Change in $R_{DS(ON)}$ with Temperature				1.1	%/ $^\circ\text{C}$	$V_{GS} = 0V, I_D = 120\text{mA}$
$G_{FS}$	Forward Transconductance			325		mS	$I_D = 100\text{mA}, V_{DS} = 10V$
$C_{ISS}$	Input Capacitance			200	300	pF	$V_{GS} = -10V, V_{DS} = 25V$ $f = 1 \text{ MHz}$
$C_{OSS}$	Common Source Output Capacitance			12	30		
$C_{RSS}$	Reverse Transfer Capacitance			1	5		
$t_{d(ON)}$	Turn-ON Delay Time				10	ns	$V_{DD} = 25V,$ $I_D = 150\text{mA},$ $R_{GEN} = 25\Omega$
$t_r$	Rise Time				15		
$t_{d(OFF)}$	Turn-OFF Delay Time				15		
$t_f$	Fall Time				20		
$V_{SD}$	Diode Forward Voltage Drop				1.8	V	$V_{GS} = -10V, I_{SD} = 120\text{mA}$
$t_{rr}$	Reverse Recovery Time			800		ns	$V_{GS} = -10V, I_{SD} = 1A$

### Notes:

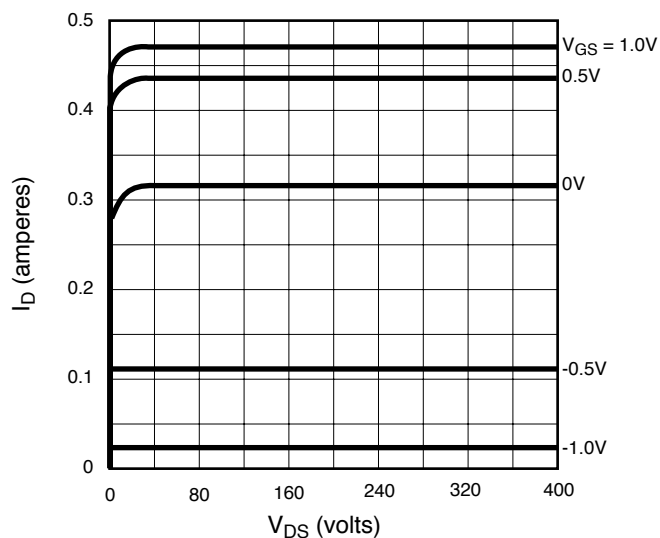
1. All D.C. parameters 100% tested at  $25^\circ\text{C}$  unless otherwise stated. (Pulse test: 300 $\mu\text{s}$  pulse, 2% duty cycle.)
2. All A.C. parameters sample tested.

## Switching Waveforms and Test Circuit

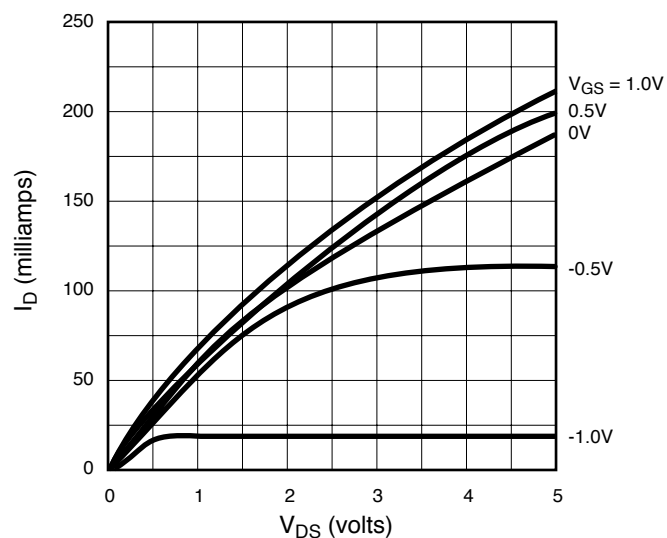


# Typical Performance Curves

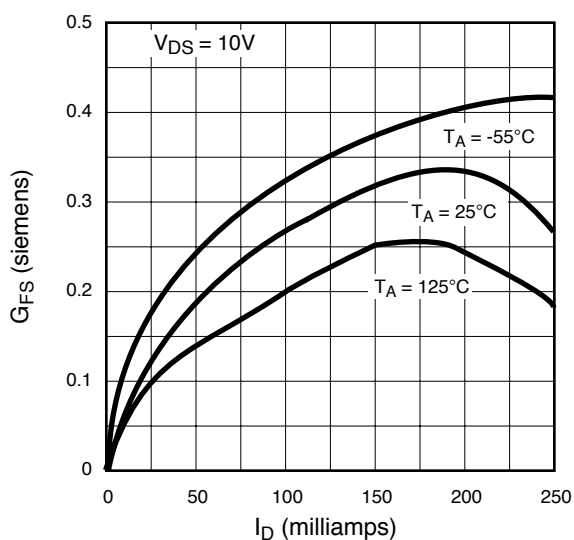
Output Characteristics



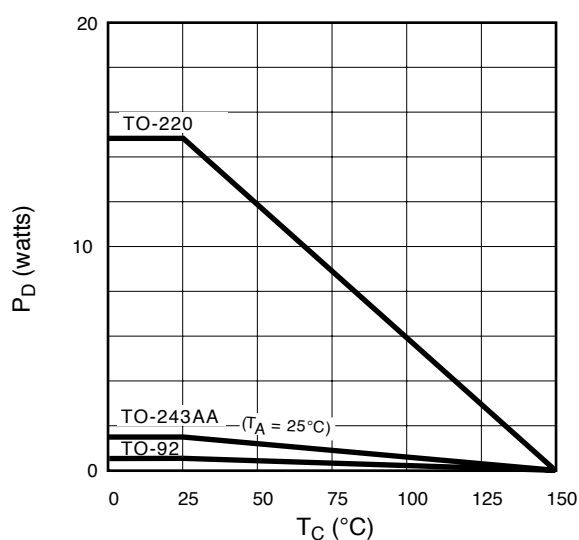
Saturation Characteristics



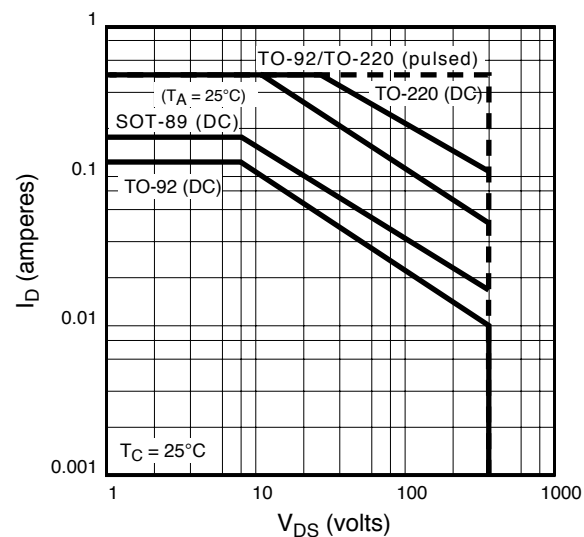
Transconductance vs. Drain Current



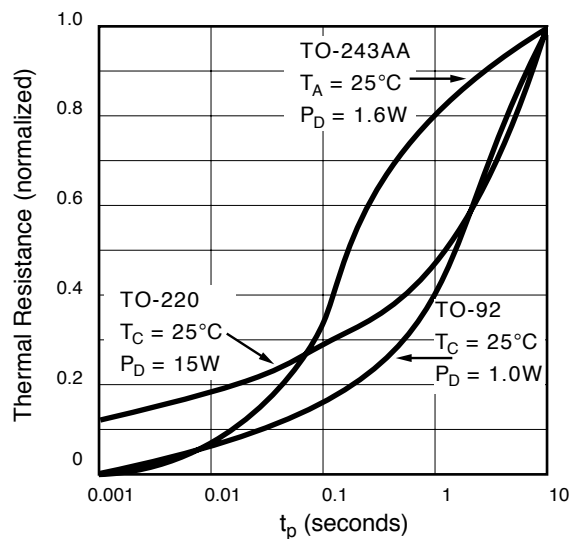
Power Dissipation vs. Temperature



Maximum Rated Safe Operating Area



Thermal Response Characteristics



# Typical Performance Curves

